etter analysis counts



Flexible Design, Unyielding Performance

fleX-Beam[™] is a unique, compact X-ray generator that combines a low-powered X-ray source and a precisely-aligned polycapillary optic to deliver a bright X-ray beam for advanced material analysis. fleX-Beam is available in several standard focused or collimated beam configurations and can also be customized for specific applications.

Industry-Leading Performance

- fleX-Beam's intensity is up to 10,000 times greater than conventional pinhole collimators
- Focal spot as small as 5µm @ Rh Ka (20.162keV)
- 50 watt performance exceeds conventional kilowatt-powered X-ray tubes
- Integrated safety shutter & 8-position filter wheel

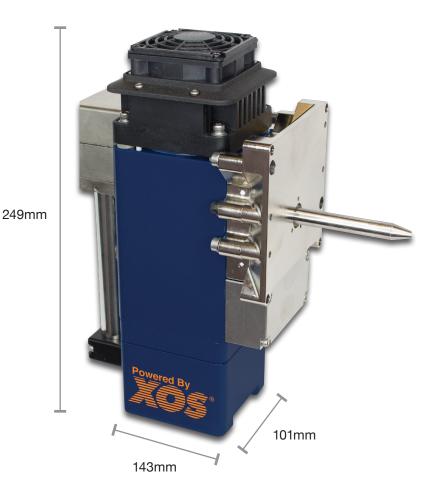
Simple Integration

• This comprehensive solution is compact and easily integrates with any instrument or system

Easy Serviceability & Field-Alignment

 Innovative design allows for the ability to interchange different optics, as well as service the X-ray source in the field

fleX-Beam



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Custom Solutions

fleX-Beam[™] can be used in different applications where a compact X-ray source with high photon flux is required. Various configurations are available to be used in µ-XRF, diffraction, in-line process monitoring or in-situ analysis, and medical imaging applications. XOS provides custom fleX-Beam optics based on customer requirements.

Standard fleX-Beam Models

Highly-Focusing Optics							
Working distance (mm)	2	4	9	20	50	100	
Focal spot size* (μm, FWHM)	8	15	25	45	100	180	
Output beam intensity* (photons/s)	3.5 x 10 ⁷	7.0 x 10 ⁷	1.5 x 10 ⁸	2.0 x 10 ⁸	3.0 x 10 ⁸	4.0 x 10 ⁸	

	Typical Applications: XRD - Residual Stress Analysis					
Output convergent angle (degree)	0.25	0.5	1	2	 Laue Diffraction Powder Diffraction * Note: For Cu Ka radiation using a 100 Cu-anode x-ray source at 50 kV/1mA Working distance is 140mm and foca size is 0.5mm 	
Output beam intensity	5.0 x 10 ⁸	1.6 x 10 ⁹	5.0 x 10 ⁹	1.6 x 10 ¹⁰		

Typical Applications: Micro XRF

- Film & Plating Thickness

* Note: For Mo Ka radiation using a 100µm, Mo-anode x-ray source at 50 kV/1mA

	P C PP C C C
	Residual Stress Analysis
	Laue Diffraction

Note: For Cu Ka radiation using a 100µm, Cu-anode x-ray source at 50 kV/1mA. Working distance is 140mm and focal spot size is 0.5mm

Highly-Collimating Optics								Typical Applications: XRD & WDS	
Output beam diameter (mm)	0.5	1	2	3	4	6	10	20	 Powder Diffraction Texture & Strain Measurement Wavelength-Dispersive Spectrometer
Output beam intensity (photon/s)*	3.0 x 10 ⁸	1.2 x 10 ⁹	3.5 x 10 ⁹	6.5 x 10º	1.0 x 10 ¹⁰	1.3 x 10 ¹⁰	1.8 x 10 ¹⁰	2.5 x 10 ¹⁰	* Note: For Cu Kα radiation using a 100μm, Cu-anode x-ray source at 50 kV/1mA. Output beam divergent angle is 0.2°



PCS50 controller is available for research applications. It offers precise command and custom settings.

Dimensions: 382mm W x 335mm L x 107mm H

Technical Specifications

Available Targets*	Cr, Cu, Mo, Rh, W			
Nominal Output Power	50 kV / 1.0 mA / 50 W			
Stability	<0.5% RSD per °C over 8 hours			
Ambient Operating Temp	20°-35° C			
Cooling Mode	Integrated forced air			
Dimensions	101mm W x 143mm L (w/o optic) x 249mm H			
Weight	5.9kg			
Included: Built in safety shutter & 8-position filter wheel				

*Other target materials may be available upon request.



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